# 74HC574; 74HCT574

Octal D-type flip-flop; positive edge-trigger; 3-state

Rev. 8 — 30 July 2021

Product data sheet

## 1. General description

The 74HC574; 74HCT574 is an 8-bit positive-edge triggered D-type flip-flop with 3-state outputs. The device features a clock (CP) and output enable ( $\overline{OE}$ ) inputs. The flip-flops will store the state of their individual D-inputs that meet the set-up and hold time requirements on the LOW-to-HIGH clock (CP) transition. A HIGH on  $\overline{OE}$  causes the outputs to assume a high-impedance OFF-state. Operation of the  $\overline{OE}$  input does not affect the state of the flip-flops. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of  $V_{CC}$ .

#### 2. Features and benefits

- Wide supply voltage range from 2.0 to 6.0 V
- CMOS low power dissipation
- · High noise immunity
- Latch-up performance exceeds 100 mA per JESD 78 Class II Level B
- · Complies with JEDEC standards:
  - JESD8C (2.7 V to 3.6 V)
  - JESD7A (2.0 V to 6.0 V)
- Input levels:
  - For 74HC574: CMOS level
  - For 74HCT574: TTL level
- 3-state non-inverting outputs for bus oriented applications
- 8-bit positive, edge-triggered register
- · Common 3-state output enable input
- ESD protection:
- HBM JESD22-A114F exceeds 2000 V
  - MM JESD22-A115-A exceeds 200 V
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C

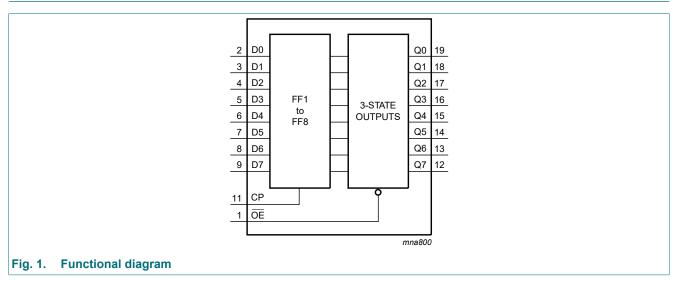
## 3. Ordering information

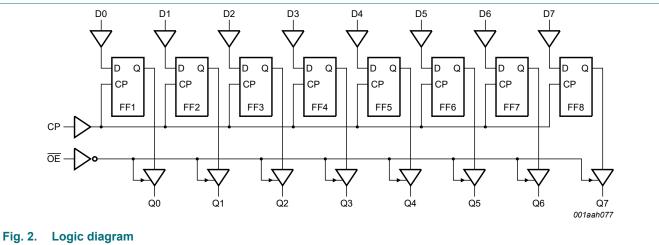
Table 1. Ordering information

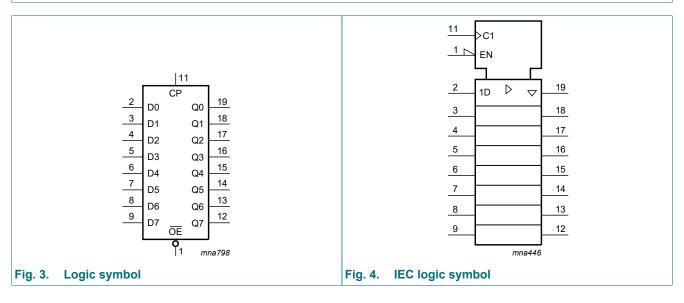
Type number	Package								
	Temperature range	Name	Description	Version					
74HC574D	-40 °C to +125 °C	SO20	plastic small outline package; 20 leads;	SOT163-1					
74HCT574D			body width 7.5 mm						
74HC574PW	-40 °C to +125 °C	TSSOP20	plastic thin shrink small outline package;	SOT360-1					
74HCT574PW			20 leads; body width 4.4 mm						



## 4. Functional diagram

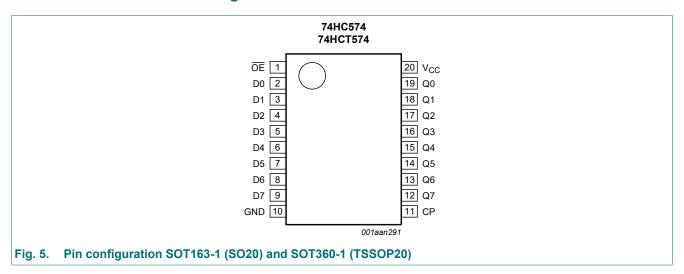






## 5. Pinning information

#### 5.1. Pinning



#### 5.2. Pin description

#### Table 2. Pin description

Symbol	Pin	Description
ŌĒ	1	3-state output enable input (active LOW)
D0, D1, D2, D3, D4, D5, D6, D7	2, 3, 4, 5, 6, 7, 8, 9	data inputs
GND	10	ground (0 V)
СР	11	clock input (LOW-to-HIGH, edge triggered)
Q0, Q1, Q2, Q3, Q4, Q5, Q6, Q7	19, 18, 17, 16, 15, 14, 13, 12	3-state flip-flop outputs
V <sub>CC</sub>	20	supply voltage

## 6. Functional description

#### Table 3. Function table

H = HIGH voltage level; h = HIGH voltage level one setup time prior to the HIGH-to-LOW CP transition;

L = LOW voltage level; I = LOW voltage level one setup time prior to the HIGH-to-LOW CP transition;

 $Z = high-impedance OFF-state; \uparrow = LOW-to-HIGH clock transition.$ 

Operating mode	Input		Internal	Output	
	ŌĒ	СР	Dn	flip-flop	Qn
Load and read register	L	1	I	L	L
	L	1	h	Н	Н
Load register and disable output	Н	<b>↑</b>	I	L	Z
	Н	<b>↑</b>	h	Н	Z

## 7. Limiting values

#### **Table 4. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		-0.5	+7	V
I <sub>IK</sub>	input clamping current	$V_1 < -0.5 \text{ V or } V_1 > V_{CC} + 0.5 \text{ V}$	-	±20	mA
I <sub>OK</sub>	output clamping current	$V_{O} < -0.5 \text{ V or } V_{O} > V_{CC} + 0.5 \text{ V}$	-	±20	mA
Io	output current	$V_O = -0.5 \text{ V to } (V_{CC} + 0.5 \text{ V})$	-	±35	mA
I <sub>CC</sub>	supply current		-	+70	mA
I <sub>GND</sub>	ground current		-	-70	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	[1]	-	500	mW

<sup>[1]</sup> For SOT163-1 (SO20) package:  $P_{tot}$  derates linearly with 12.3 mW/K above 109 °C. For SOT360-1 (TSSOP20) package:  $P_{tot}$  derates linearly with 10.0 mW/K above 100 °C.

## 8. Recommended operating conditions

#### Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V)

Symbol	Parameter	Conditions	74HC574			74HCT574			Unit
			Min	Тур	Max	Min	Тур	Max	
V <sub>CC</sub>	supply voltage		2.0	5.0	6.0	4.5	5.0	5.5	V
VI	input voltage		0	-	V <sub>CC</sub>	0	-	V <sub>CC</sub>	V
Vo	output voltage		0	-	V <sub>CC</sub>	0	-	V <sub>CC</sub>	V
T <sub>amb</sub>	ambient temperature		-40	+25	+125	-40	+25	+125	°C
Δt/ΔV	input transition rise and fall rate	V <sub>CC</sub> = 2.0 V	-	-	625	-	-	-	ns/V
		V <sub>CC</sub> = 4.5 V	-	1.67	139	-	1.67	139	ns/V
		V <sub>CC</sub> = 6.0 V	-	-	83	-	-	-	ns/V

### 9. Static characteristics

#### **Table 6. Static characteristics**

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	25 °C -4		-40 °C to	-40 °C to +85 °C		-40 °C to +125 °C		
			Min	Тур	Max	Min	Max	Min	Max	
74HC57	4									
$V_{IH}$	HIGH-level	V <sub>CC</sub> = 2.0 V	1.5	1.2	-	1.5	-	1.5	-	V
	input voltage	V <sub>CC</sub> = 4.5 V	3.15	2.4	-	3.15	-	3.15	-	V
		V <sub>CC</sub> = 6.0 V	4.2	3.2	-	4.2	-	4.2	-	V
$V_{IL}$	LOW-level	V <sub>CC</sub> = 2.0 V	-	0.8	0.5	-	0.5	-	0.5	V
	input voltage	V <sub>CC</sub> = 4.5 V	-	2.1	1.35	-	1.35	-	1.35	V
		V <sub>CC</sub> = 6.0 V	-	2.8	1.8	-	1.8	-	1.8	V

Symbol	Parameter	Conditions		25 °C		-40 °C t	o +85 °C	-40 °C to	+125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
V <sub>OH</sub>	HIGH-level	$V_I = V_{IH}$ or $V_{IL}$								
	output voltage	I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 2.0 V	1.9	2.0	-	1.9	-	1.9	-	V
		I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 4.5 V	4.4	4.5	-	4.4	-	4.4	-	V
		I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 6.0 V	5.9	6.0	-	5.9	-	5.9	-	V
		$I_{O}$ = -6.0 mA; $V_{CC}$ = 4.5 V	3.98	4.32	-	3.84	-	3.7	-	V
		I <sub>O</sub> = -7.8 mA; V <sub>CC</sub> = 6.0 V	5.48	5.81	-	5.34	-	5.2	-	V
V <sub>OL</sub>	LOW-level	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>								
	output voltage	I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 2.0 V	-	0	0.1	-	0.1	-	0.1	V
		I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 4.5 V	-	0	0.1	-	0.1	-	0.1	V
		I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 6.0 V	-	0	0.1	-	0.1	-	0.1	V
		I <sub>O</sub> = 6.0 mA; V <sub>CC</sub> = 4.5 V	-	0.15	0.26	-	0.33	-	0.4	V
		I <sub>O</sub> = 7.8 mA; V <sub>CC</sub> = 6.0 V	-	0.16	0.26	-	0.33	-	0.4	V
I <sub>I</sub>	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 6.0 \text{ V}$	-	-	±0.1	-	±1.0	-	±1.0	μA
l <sub>OZ</sub>	OFF-state output current	$V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 6.0$ V; $V_O = V_{CC}$ or GND	-	-	±0.5	-	±5.0	-	±10.0	μA
I <sub>CC</sub>	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 6.0 \text{ V}$	-	-	8.0	-	80	-	160	μA
C <sub>I</sub>	input capacitance		-	3.5	-	-	-	-	-	pF
74HCT5	74		'	'	'	'			'	
V <sub>IH</sub>	HIGH-level input voltage	V <sub>CC</sub> = 4.5 V to 5.5 V	2.0	1.6	-	2.0	-	2.0	-	V
V <sub>IL</sub>	LOW-level input voltage	V <sub>CC</sub> = 4.5 V to 5.5 V	-	1.2	8.0	-	0.8	-	0.8	V
V <sub>OH</sub>	HIGH-level	$V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 4.5 V$								
	output voltage	I <sub>O</sub> = -20 μA	4.4	4.5	-	4.4	-	4.4	-	V
		I <sub>O</sub> = -6 mA	3.98	4.32	-	3.84	-	3.7	-	V
V <sub>OL</sub>	LOW-level	$V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 4.5 V$								
	output voltage	Ι <sub>Ο</sub> = 20 μΑ	-	0	0.1	-	0.1	-	0.1	V
		I <sub>O</sub> = 6.0 mA	-	0.16	0.26	-	0.33	-	0.4	V
I <sub>I</sub>	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 5.5 \text{ V}$	-	-	±0.1	-	±1.0	-	±1.0	μA
l <sub>OZ</sub>	OFF-state output current	$V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 5.5$ V; $V_O = V_{CC}$ or GND	-	-	±0.5	-	±5.0	-	±10	μΑ
I <sub>CC</sub>	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5 \text{ V}$	-	-	8.0	-	80	-	160	μA
ΔI <sub>CC</sub>	additional supply current	$V_I = V_{CC} - 2.1 \text{ V};$ other inputs at $V_{CC}$ or GND; $V_{CC} = 4.5 \text{ V}$ to 5.5 V; $I_O = 0 \text{ A}$								
		per input pin; Dn inputs	-	50	180	-	225	-	245	μΑ
		per input pin; OE input	-	125	450	-	563	-	613	μΑ
		per input pin; CP input	-	150	540	-	675	-	735	μΑ
Cı	input capacitance		-	3.5	-	-	-	-	-	pF

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## 10. Dynamic characteristics

#### **Table 7. Dynamic characteristics**

Voltages are referenced to GND (ground = 0 V);  $C_L$  = 50 pF unless otherwise specified; for test circuit see Fig. 9.

Symbol	Parameter	Conditions		25 °C		-40 °C t	o +85 °C	-40 °C to	o +125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
74HC57	4									
t <sub>pd</sub>	propagation	CP to Qn; see Fig. 6	]							
	delay	V <sub>CC</sub> = 2.0 V	-	47	150	-	190	-	225	ns
		V <sub>CC</sub> = 4.5 V	-	17	30	-	35	-	45	ns
		V <sub>CC</sub> = 5 V; C <sub>L</sub> = 15 pF	-	14	-	-	-	-	-	ns
		V <sub>CC</sub> = 6.0 V	-	14	26	-	33	-	38	ns
t <sub>en</sub>	enable time	OE to Qn; see Fig. 8	2]							
		V <sub>CC</sub> = 2.0 V	-	44	140	-	175	-	210	ns
		V <sub>CC</sub> = 4.5 V	-	16	28	-	35	-	42	ns
		V <sub>CC</sub> = 6.0 V	-	13	24	-	30	-	36	ns
t <sub>dis</sub>	disable time	OE to Qn; see Fig. 8	3]							
		V <sub>CC</sub> = 2.0 V	-	39	125	-	155	-	190	ns
		V <sub>CC</sub> = 4.5 V	-	14	25	-	31	-	38	ns
		V <sub>CC</sub> = 6.0 V	-	11	21	-	26	-	32	ns
t <sub>t</sub>	transition	Qn; see Fig. 6	1]							
	time	V <sub>CC</sub> = 2.0 V	-	14	60	-	75	-	90	ns
	V <sub>CC</sub> = 4.5 V	-	5	12	-	15	-	18	ns	
	V <sub>CC</sub> = 6.0 V	-	4	10	-	13	-	15	ns	
t <sub>W</sub>	pulse width	CP HIGH or LOW; see Fig. 7								
		V <sub>CC</sub> = 2.0 V	80	14	-	100	-	120	-	ns
		V <sub>CC</sub> = 4.5 V	16	5	-	20	-	24	-	ns
		V <sub>CC</sub> = 6.0 V	14	4	-	17	-	20	-	ns
t <sub>su</sub>	set-up time	Dn to CP; see Fig. 7								
		V <sub>CC</sub> = 2.0 V	60	6	-	75	-	90	-	ns
		V <sub>CC</sub> = 4.5 V	12	2	-	15	-	18	-	ns
		V <sub>CC</sub> = 6.0 V	10	2	-	13	-	15	-	ns
t <sub>h</sub>	hold time	Dn to CP; see Fig. 7								
		V <sub>CC</sub> = 2.0 V	5	0	-	5	-	5	-	ns
		V <sub>CC</sub> = 4.5 V	5	0	-	5	-	5	-	ns
		V <sub>CC</sub> = 6.0 V	5	0	-	5	-	5	-	ns
f <sub>max</sub>	maximum	CP; see Fig. 6								
	frequency	V <sub>CC</sub> = 2.0 V	6.0	37	-	4.8	-	4.0	-	MHz
		V <sub>CC</sub> = 4.5 V	30	112	-	24	-	20	-	MHz
		V <sub>CC</sub> = 5 V; C <sub>L</sub> = 15 pF	-	123	-	-	-	-	-	MHz
		V <sub>CC</sub> = 6.0 V	35	133	-	28	-	24	-	MHz
C <sub>PD</sub>	power dissipation capacitance	$C_L = 50 \text{ pF; } f = 1 \text{ MHz;}$ $V_I = \text{GND to } V_{CC}$	5] -	22	-	-	-	-	-	pF

Symbol	Parameter	Conditions		25 °C		-40 °C t	o +85 °C	-40 °C t	o +125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
74HCT5	74							<u> </u>	<u> </u>	
t <sub>pd</sub>	propagation	CP to Qn; see Fig. 6 [1]								
	delay	V <sub>CC</sub> = 4.5 V	-	18	33	-	41	-	50	ns
		V <sub>CC</sub> = 5 V; C <sub>L</sub> = 15 pF	-	15	-	-	-	-	-	ns
t <sub>en</sub>	enable time	OE to Qn; see Fig. 8 [2]								
		V <sub>CC</sub> = 4.5 V	-	19	33	-	41	-	50	ns
t <sub>dis</sub>	disable time	OE to Qn; see Fig. 8 [3]								
		V <sub>CC</sub> = 4.5 V	-	16	28	-	35	-	42	ns
t <sub>t</sub>	transition	Qn; see <u>Fig. 6</u> [4]								
	time	V <sub>CC</sub> = 4.5 V	-	5	12	-	15	-	18	ns
t <sub>W</sub>	pulse width	CP HIGH or LOW; see Fig. 7								
		V <sub>CC</sub> = 4.5 V	16	7	-	20	-	24	-	ns
t <sub>su</sub>	set-up time	Dn to CP; see Fig. 7								
		V <sub>CC</sub> = 4.5 V	12	3	-	15	-	18	-	ns
t <sub>h</sub>	hold time	Dn to CP; see Fig. 7								
		V <sub>CC</sub> = 4.5 V	5	-1	-	5	-	5	-	ns
f <sub>max</sub>	maximum	CP; see Fig. 6								
	frequency	V <sub>CC</sub> = 4.5 V	30	69	-	24	-	20	-	MHz
		$V_{CC} = 5 \text{ V}; C_L = 15 \text{ pF}$	-	76	-	-	-	-	-	MHz
C <sub>PD</sub>	power dissipation capacitance	$C_L = 50 \text{ pF; } f = 1 \text{ MHz;}$ [5] V <sub>I</sub> = GND to V <sub>CC</sub> - 1.5 V	-	25	-	-	-	-	-	pF

- [1]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .
- [2] [3]  $t_{en}$  is the same as  $t_{PZH}$  and  $t_{PZL}$ .  $t_{dis}$  is the same as  $t_{PLZ}$  and  $t_{PHZ}$ .

- t<sub>dis</sub> is the same as t<sub>THL</sub> and t<sub>TLH</sub>.
   C<sub>PD</sub> is used to determine the dynamic power dissipation (P<sub>D</sub> in μW).
   P<sub>D</sub> = C<sub>PD</sub> x V<sub>CC</sub><sup>2</sup> x f<sub>i</sub> x N + Σ(C<sub>L</sub> x V<sub>CC</sub><sup>2</sup> x f<sub>o</sub>) where:

 $f_i$  = input frequency in MHz;

f<sub>o</sub> = output frequency in MHz;

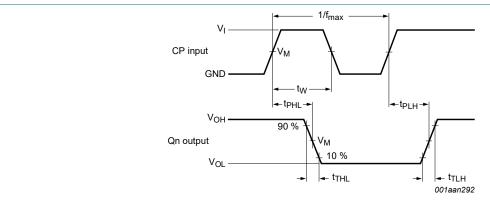
C<sub>L</sub> = output load capacitance in pF;

V<sub>CC</sub> = supply voltage in V;

N = number of inputs switching;  $\Sigma(C_L \ x \ V_{CC} \ ^2 \ x \ f_o) = sum \ of \ outputs.$ 

**Product data sheet** 

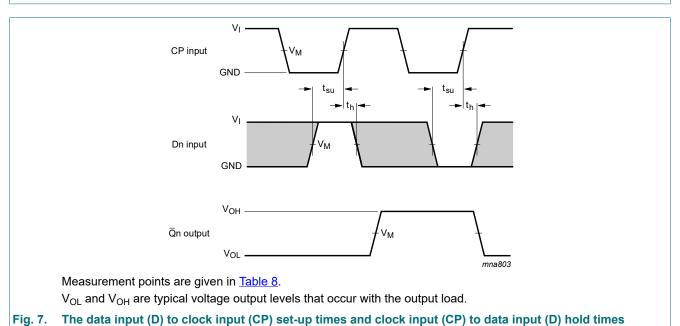
#### 10.1. Waveforms and test circuit



Measurement points are given in Table 8.

V<sub>OL</sub> and V<sub>OH</sub> are typical voltage output levels that occur with the output load.

Fig. 6. Propagation delay input (CP) to output (Qn), output transition time, clock input (CP) pulse width and the maximum frequency (CP)



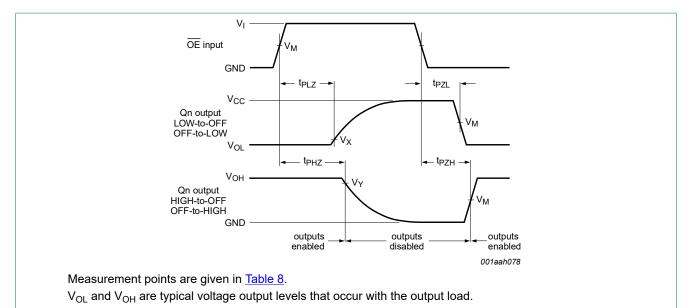
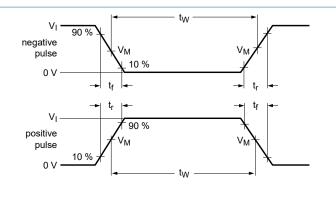
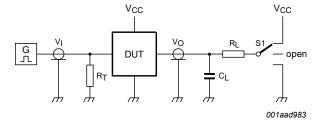


Fig. 8. Enable and disable times

**Table 8. Measurement points** 

Туре	Input	Output					
	V <sub>M</sub>	V <sub>M</sub>	V <sub>X</sub>	V <sub>Y</sub>			
74HC574	0.5V <sub>CC</sub>	0.5V <sub>CC</sub>	0.1V <sub>CC</sub>	0.9V <sub>CC</sub>			
74HCT574	1.3 V	1.3 V	0.1V <sub>CC</sub>	0.9V <sub>CC</sub>			





Test data is given in Table 9.

Definitions test circuit:

 $R_T$  = Termination resistance should be equal to output impedance  $Z_0$  of the pulse generator.

C<sub>L</sub> = Load capacitance including jig and probe capacitance.

R<sub>L</sub> = Load resistance.

S1 = Test selection switch.

#### Fig. 9. Test circuit for measuring switching times

Table 9. Test data

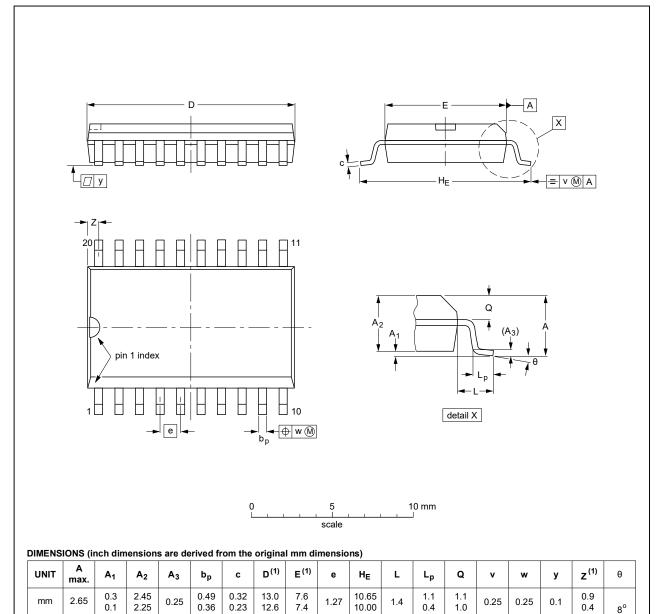
Туре	Input Load		S1 position				
	V <sub>I</sub>	t <sub>r</sub> , t <sub>f</sub>	CL	$R_L$	t <sub>PHL</sub> , t <sub>PLH</sub>	t <sub>PZH</sub> , t <sub>PHZ</sub>	$t_{PZL}, t_{PLZ}$
74HC574	V <sub>CC</sub>	6 ns	15 pF, 50 pF	1 kΩ	open	GND	V <sub>CC</sub>
74HCT574	3 V	6 ns	15 pF, 50 pF	1 kΩ	open	GND	V <sub>CC</sub>

**Product data sheet** 

## 11. Package outline



SOT163-1



## inches

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

0.019

0.014

0.013

0.009

0.51

0.49

0.30

0.29

OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT163-1	075E04	MS-013				<del>99-12-27</del> 03-02-19

0.05

0.419

0.394

0.055

0.043

0.016

0.043

0.039

0.01

0.01

Fig. 10. Package outline SOT163-1 (SO20)

0.012

0.004

0.096

0.089

0.01

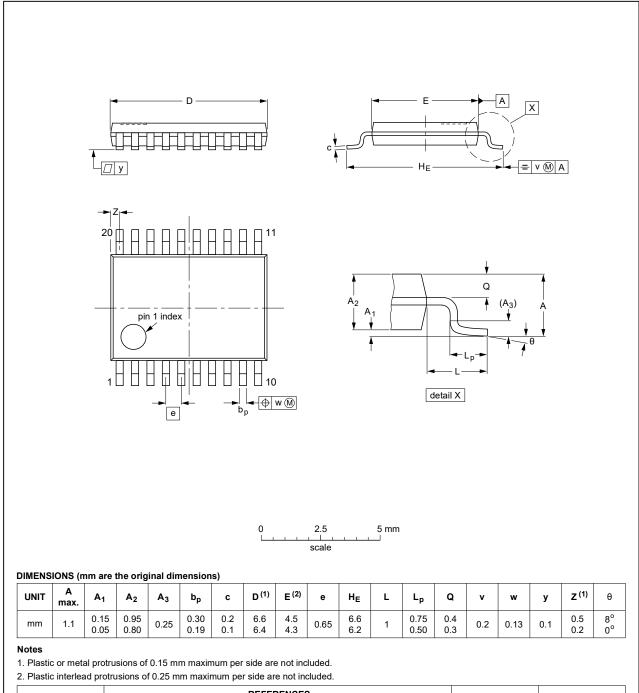
**Product data sheet** 

0.035

0.016

TSSOP20: plastic thin shrink small outline package; 20 leads; body width 4.4 mm

SOT360-1



OUTLINE VERSION	REFERENCES				EUROPEAN	ISSUE DATE
	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT360-1		MO-153				<del>99-12-27</del> 03-02-19

Fig. 11. Package outline SOT360-1 (TSSOP20)

**Product data sheet** 

## 12. Abbreviations

#### **Table 10. Abbreviations**

Acronym	Description
CMOS	Complementary Metal Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
НВМ	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

## 13. Revision history

#### Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes	
74HC_HCT574 v.8	20210730	Product data sheet	-	74HC_HCT574 v.7	
Modifications:	<ul> <li>The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia.</li> <li>Legal texts have been adapted to the new company name where appropriate.</li> <li>Type numbers 74HC574DB and 74HCT574DB (SOT339-1/SSOP20) removed.</li> <li>Section 2 updated.</li> <li>Section 7: Derating values for P<sub>tot</sub> total power dissipation updated.</li> </ul>				
74HC_HCT574 v.7	20160304	Product data sheet	-	74HC_HCT574 v.6	
Modifications:	Type numbers 74HC574N and 74HCT574N (SOT146-1) removed.				
74HC_HCT574 v.6	20150126	Product data sheet	-	74HC_HCT574 v.5	
Modifications:	<u>Section 7</u> : Power dissipation capacitance condition for 74HCT574 is corrected.				
74HC_HCT574 v.5	20120425	Product data sheet	-	74HC_HCT574 v.4	
Modifications:	V <sub>X</sub> and V <sub>Y</sub> measurement points added to <u>Table 8</u> .				
74HC_HCT574 v.4	20111219	Product data sheet	-	74HC_HCT574 v.3	
Modifications:	Legal pages updated.				
74HC_HCT574 v.3	20101215	Product data sheet	-	74HC_HCT574_CNV v.2	
74HC_HCT574_CNV v.2	19970827	Product specification	-	-	

### 14. Legal information

#### **Data sheet status**

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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#### Octal D-type flip-flop; positive edge-trigger; 3-state

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